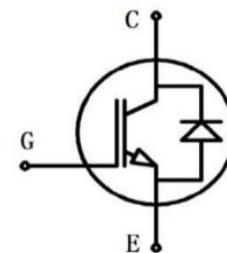


$V_{CES} = 1350V$ ,  $I_C = 30A$ ,  $V_{CE(sat)} = 2.3V$ 
**Features:**

- Trench and Field-stop technology
- Low collector to emitter saturation voltage
- Optimized for Fast Switching
- Easy parallel switching capability
- Short circuit withstands time - 10μs


**Applications:**

- Soft switching application
- Uninterrupted Power Supply
- Frequency Converters

**Absolute Maximum Ratings ( $T_J = 25^\circ C$  unless otherwise noted)**

Symbol	Parameter	Conditions	Value	Unit
$V_{CES}$	Collector to Emitter Voltage		1350	V
$V_{GES}$	Continuous Gate to Emitter Voltage		$\pm 20$	V
$I_C$	Continuous Collector Current	$T_C = 100^\circ C$	30	A
		$T_C = 25^\circ C$	60	A
$I_{CM}$	Pulse Collector Current	Pulse width limited by $T_{jmax}$	120	A
$P_D$	Maximum Power Dissipation (IGBT)	$T_C = 25^\circ C, T_J = 175^\circ C$	417	W
$t_{sc}$	Short Circuit Withstand Time	$V_{CC} = 600V, V_{GE} \leq 15V$	10	μs

**Electrical Characteristics of IGBT ( $T_J = 25^\circ C$ )**
**Static characteristics**

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$V_{GE(th)}$	Gate-Emitter Threshold Voltage	$I_C = 1mA, V_{CE} = V_{GE}, T_J = 25^\circ C$	4.9	5.9	6.9	V
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage	$I_C = 30A, V_{GE} = 15V$	-	2.3	-	V
		$T_J = 125^\circ C$	-	2.8	-	
$I_{CES}$	Collector-Emitter Leakage Current	$V_{GE} = 0V, V_{CE} = V_{CES}, T_J = 25^\circ C$	-	-	1.0	mA
$I_{GES}$	Gate-Emitter Leakage Current	$V_{GE} = \pm 20V, V_{CE} = 0V, T_J = 25^\circ C$	-100	-	100	nA
$C_{iss}$	Input capacitance	$V_{CE}=25V, V_{GE}=0V, f=1MHz$	-	2485	-	pF
$C_{oss}$	Output capacitance		-	157	-	
$C_{rss}$	Reverse transfer capacitance		-	72	-	
$R_{gint}$	Internal gate resistor			1.3		Ω

**Switching Characteristics**

$t_{d(on)}$	Turn-on Delay Time	$V_{CC}=600V, I_C=30A,$ $V_{GE}=\pm 15V, L=525\mu H,$ $R_g=4.8\Omega$	$T_J = 25^\circ C$		21		ns	
			$T_J = 125^\circ C$		21			
$t_r$	Rise Time		$T_J = 25^\circ C$		24		ns	
			$T_J = 125^\circ C$		25			
$t_{d(off)}$	Turn-off Delay Time		$T_J = 25^\circ C$		93		ns	
			$T_J = 125^\circ C$		100			
$t_f$	Fall Time		$T_J = 25^\circ C$		286		ns	
			$T_J = 125^\circ C$		360			
$E_{on}$	Turn-on Switching Loss		$T_J = 25^\circ C$		3.0		mJ	
			$T_J = 125^\circ C$		3.3			
$E_{off}$	Turn-off Switching Loss		$T_J = 25^\circ C$		1.5		mJ	
			$T_J = 125^\circ C$		2.3			
$R_{\theta JC}$	Junction-To-Case (IGBT)				0.36		K/W	

**Electrical Characteristics of Diode ( $T_J = 25^\circ C$ )**
**Static characteristics**

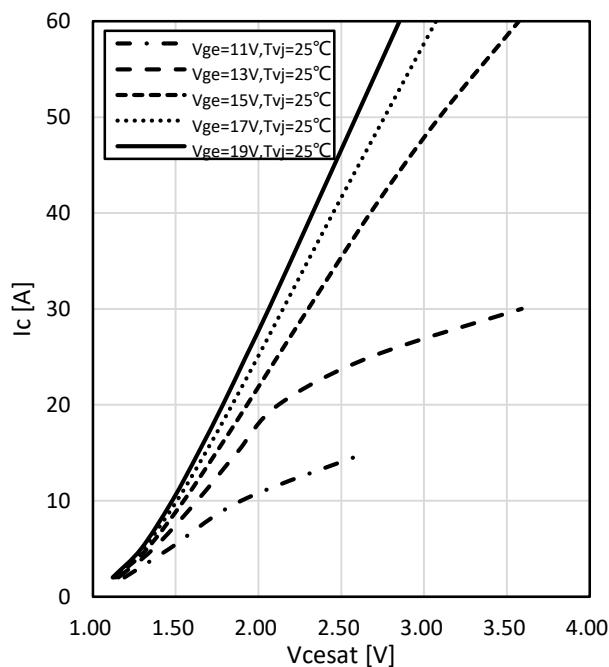
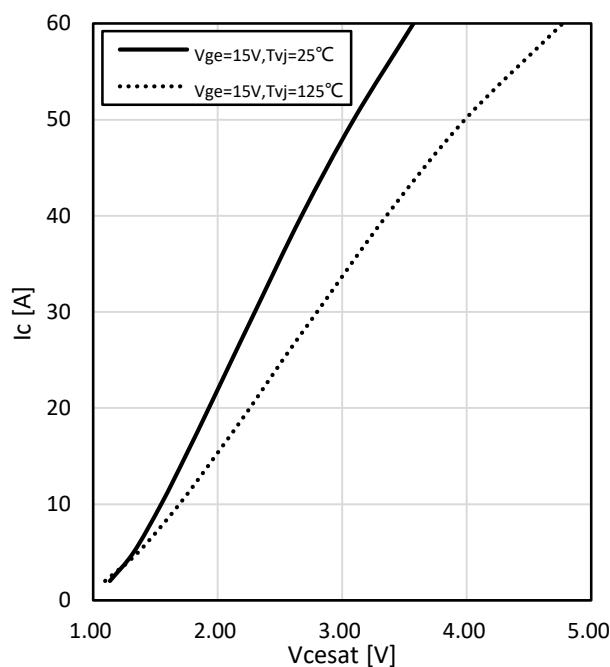
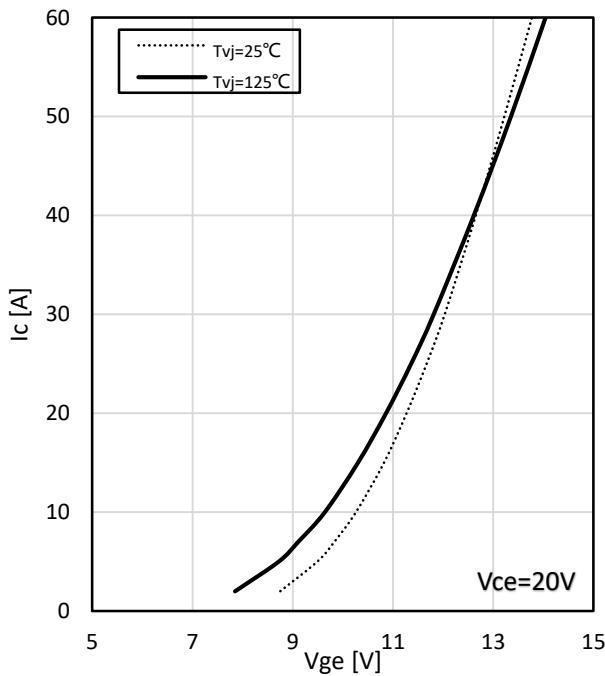
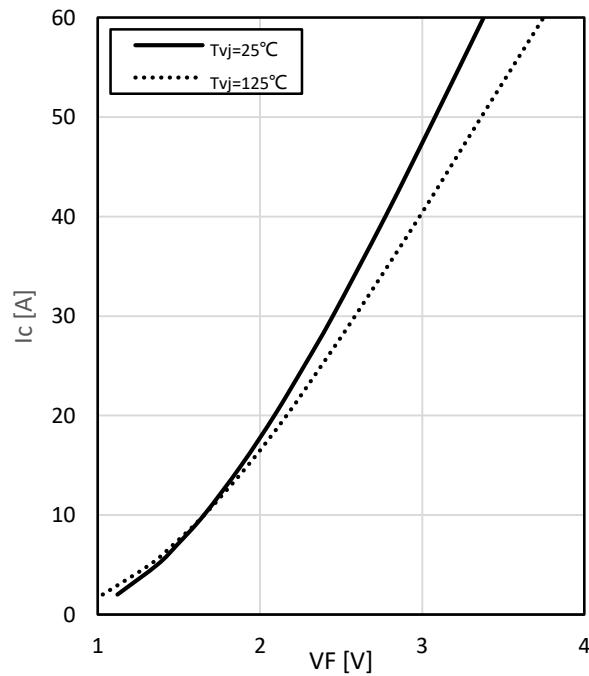
Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$V_{FM}$	Forward Voltage	$I_F=30A, V_{GE}=0V$	$T_J = 25^\circ C$		2.4		V
			$T_J = 125^\circ C$		2.6		

**Switching Characteristics**

$I_{rr}$	Peak Reverse Recovery Current	$I_F=30A,$ $V_{CC}=600V,$ $V_{GE}=-15V,$ $L=525\mu H,$ $R_g=4.8\Omega$	$T_J = 25^\circ C$		54		A	
			$T_J = 125^\circ C$		68			
$Q_{rr}$	Reverse Recovery Charge		$T_J = 25^\circ C$		4.5		$\mu C$	
			$T_J = 125^\circ C$		7.3			
$E_{rec}$	Reverse Recovery Energy		$T_J = 25^\circ C$		1.9		mJ	
			$T_J = 125^\circ C$		3.3			
$R_{\theta JC}$	Junction-To-Case (Diode)				0.95		K/W	

**Module Characteristics**

$T_J$	Junction Temperature	-40		+175	$^\circ C$
$T_{JOP}$	Operating Junction Temperature	-40		+175	$^\circ C$
$T_{stg}$	Storage Temperature	-55		+150	$^\circ C$


**Fig.1 output characteristic IGBT Inverter (typical)**

**Fig.2 output characteristic IGBT Inverter (typical)**

**Fig.3 transfer characteristic IGBT Inverter (typical)**

**Fig.4 forward characteristic of Diode Inverter (typical)**

$V_{CC}=600V$ ,  $V_{CE}=\pm 15V$

$R_G=4.8\Omega$

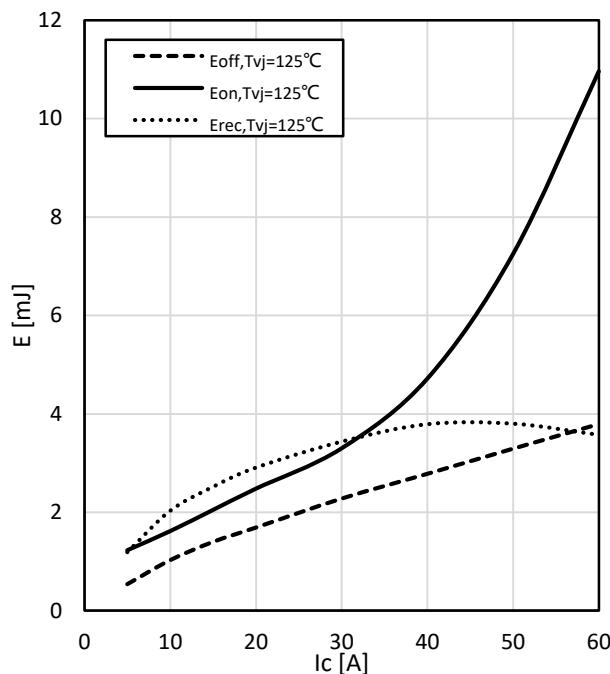


Fig.5 switching losses IGBT Inverter (typical)

$V_{CC}=600V$ ,  $V_{CE}=\pm 15V$

$I_C=30A$

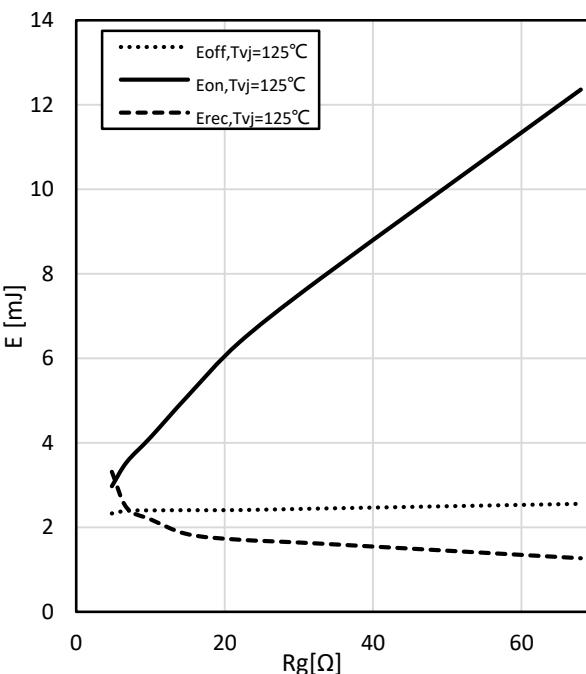


Fig.6 switching Losses vs. Gate Resistance (typical)

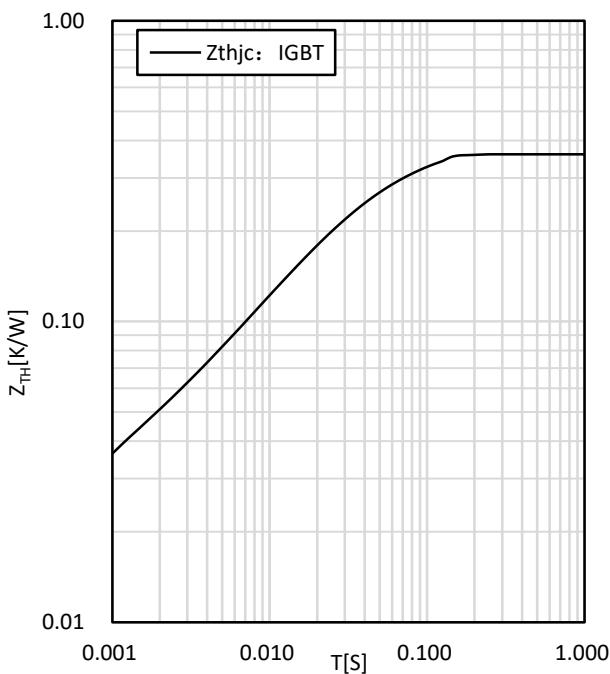


Fig.7 transient thermal impedance IGBT

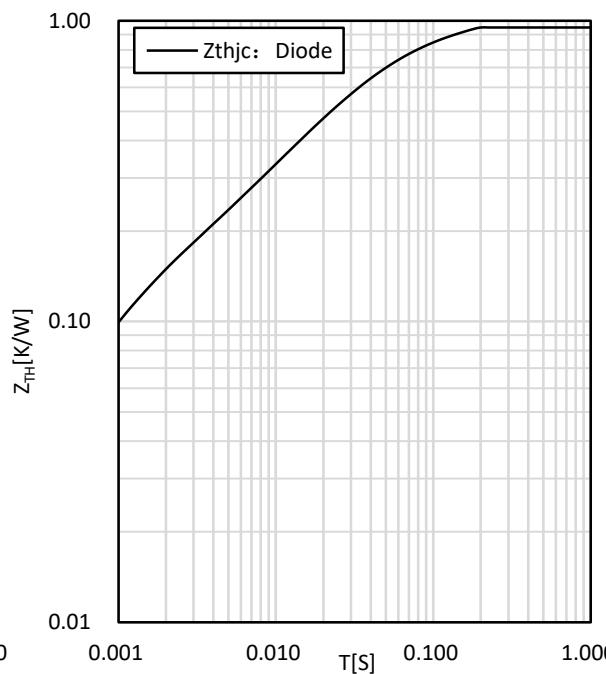
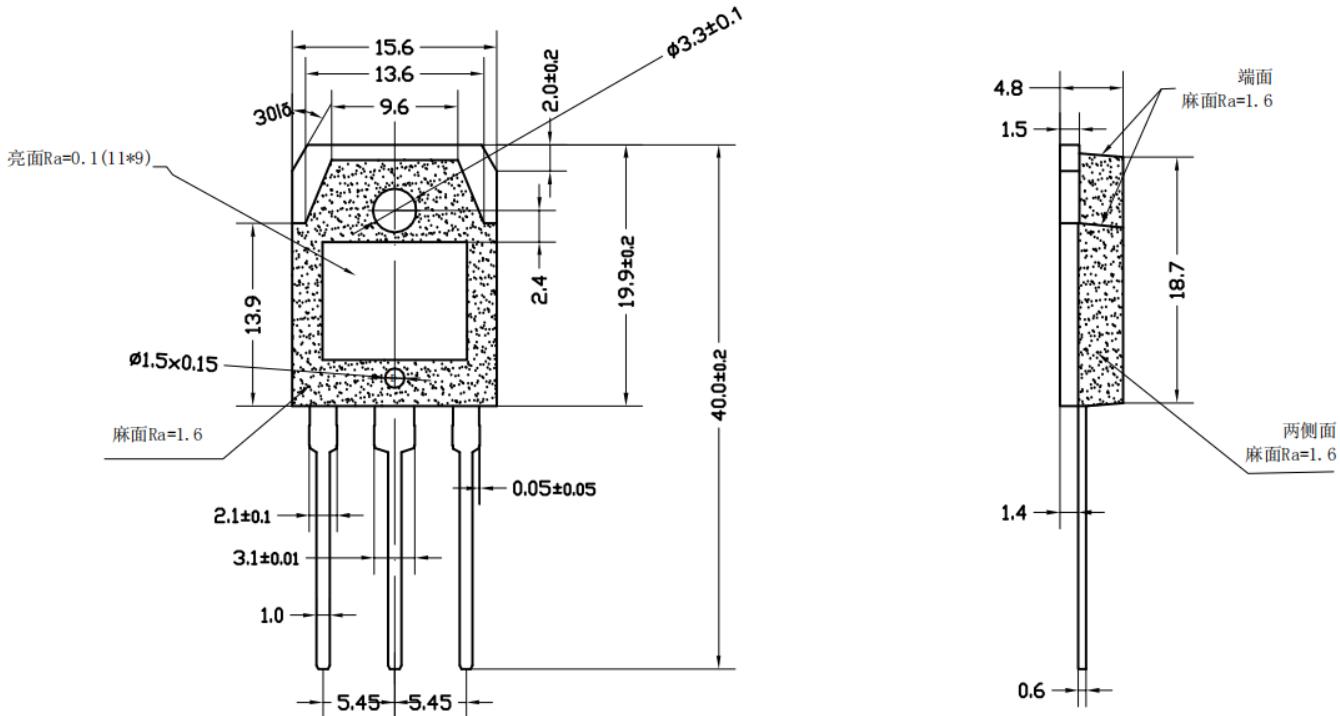


Fig.8 transient thermal impedance Diode

## Package Outline (Unit: mm): TO-3P



Note: No tolerance requirement specified  $\pm 0.1$ mm.

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